

PATENT ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Tsuyoshi Nishiwaki</td><td>01/22/2008</td></tr><tr><td>Yosuke Ootsuka</td><td>01/22/2008</td></tr><tr><td>Satoshi Kiso</td><td>01/22/2008</td></tr></tbody></table>	Name	Execution Date	Tsuyoshi Nishiwaki	01/22/2008	Yosuke Ootsuka	01/22/2008	Satoshi Kiso	01/22/2008	
Name	Execution Date								
Tsuyoshi Nishiwaki	01/22/2008								
Yosuke Ootsuka	01/22/2008								
Satoshi Kiso	01/22/2008								
RECEIVING PARTY DATA									
Name:	ASICS Corporation								
Street Address:	1-1 Minatojima-Nakamachi 7-chome,								
Internal Address:	Chuo-ku, Kobe-shi								
City:	Hyogo								
State/Country:	JAPAN								
Postal Code:	650-8555								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13288598</td></tr></tbody></table>	Property Type	Number	Application Number:	13288598					
Property Type	Number								
Application Number:	13288598								
CORRESPONDENCE DATA									
Fax Number:	(858)314-1501								
Phone:	8583141500								
Email:	kteuk@mintz.com								
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>									
Correspondent Name:	Andrew D. Skale								
Address Line 1:	3580 CARMEL MOUNTAIN ROAD SUITE 300								
Address Line 4:	SAN DIEGO, CALIFORNIA 92130								
ATTORNEY DOCKET NUMBER:	42463-508D01US								
NAME OF SUBMITTER:	Andrew D. Skale								
Total Attachments: 2 source=42463-508D01US Assignment from Parent#page1.tif source=42463-508D01US Assignment from Parent#page2.tif									

CH \$40.00 13288598

501740609

PATENT
REEL: 027308 FRAME: 0285

Assignment of Rights, Title and Interest in Invention (Multiple inventors; single assignee)	Docket No.
--	-------------------

This is an Assignment of the following rights, title and interest: (check all that apply):

- ☒ *United States of America rights, title and interest in the invention*
☒ *Foreign rights, title and interest in the invention*
☒ *United States Patent Application Serial No.* _____
Date of Execution: _____ *Date of Filing:* _____
☐ *United States Provisional Patent Application Serial No.* _____
☐ *United States Patent No(s).* _____
☒ *International (PCT) Patent Application Serial No.* PCT/JP2006/320273
☐ *Other (specify)* _____

Title of the Invention

SHOE SOLE WITH REINFORCEMENT STRUCTURE
--

Inventors (assignors)

Name	Address
Tsuyoshi NISHIWAKI	c/o ASICS Corporation 1-1, Minatojima-Nakamachi 7 Chome, Chuo-ku, Kobe, Japan
Yosuke OOTSUKA	c/o ASICS Corporation 1-1, Minatojima-Nakamachi 7 Chome, Chuo-ku, Kobe, Japan
Satoshi KISO	c/o ASICS Corporation 1-1, Minatojima-Nakamachi 7 Chome, Chuo-ku, Kobe, Japan

Assignee

Name	Address
ASICS Corporation	1-1, Minatojima-Nakamachi 7 Chome, Chuo-ku, Kobe, Japan

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures (If Notarization is desired, do not sign here and proceed to next page)

Name	Signature	Date
Tsuyoshi NISHIWAKI	Tsuyoshi Nishiwaki	22 - Jan, 2008
Yosuke OOTSUKA	Yosuke Ootsuka	22, Jan, 2008
Satoshi KISO	Satoshi Kiso	22, Jan, 2008